

Field Stop IGBT 650 V, 40 A FGA40N65SMD

General Description

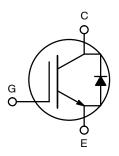
Using novel field stop IGBT technology, **onsemi**'s new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, induction heating, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: $T_J = 175$ °C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 \text{ V (Typ.)}$ @ $I_C = 40 \text{ A}$
- Fast Switching: $E_{OFF} = 6.5 \mu J/A$
- Tighten Parameter Distribution
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Solar Inverter, UPS, Welder, Induction Heating
- Telecom, ESS





TO-3P-3LD CASE 340BZ

MARKING DIAGRAM



FGA40N65SMD = Specific Device Code
A = Assembly Location
YWW = Date Code (Year & Week)

ZZ = Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
FGA40N65SMD	TO-3P-3LD (Pb-Free)	450 Units / Tube

ABSOLUTE MAXIMUM RATINGS

Symbol	Description	Value	Unit	
V _{CES}	Collector to Emitter Voltage	650	V	
V _{GES}	Gate to Emitter Voltage		±20	Α
	Transient Gate to Emitter Voltage		±30	Α
I _C	Collector Current	@ T _C = 25°C	80	Α
	Collector Current	@ T _C = 100°C	40	Α
I _{CM} (Note 1)	Pulsed Collector Current		120	Α
I _F	Diode Forward Current	@ T _C = 25°C	40	Α
	Diode Forward Current	@ T _C = 100°C	20	Α
I _{FM} (Note 1)	Pulsed Diode Maximum Forward Current		120	Α
P_{D}	Maximum Power Dissipation	@ T _C = 25°C	349	W
	Maximum Power Dissipation	@ T _C = 100°C	174	W
TJ	Operating Junction Temperature	-55 to +175	°C	
T _{stg}	Storage Temperature Range	-55 to +175	°C	
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from ca	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case, Max.	0.43	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case, Max.	1.5	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Cond	Min.	Тур.	Max.	Unit	
V_{FM}	Diode Forward Voltage	I _F = 20 A	T _C = 25°C	-	2.1	2.6	V
			T _C = 175°C	-	1.7	-	
E _{rec}	Reverse Recovery Energy	l _F = 20 A, dl _F /dt = 200 A/μs	T _C = 175°C	-	96	-	μJ
t _{rr}	Diode Reverse Recovery Time	αιρ/αι = 200 Α/μδ	T _C = 25°C	-	42	-	ns
			T _C = 175°C	-	200	-	
I _{rr}	Diode Peak Reverse Recovery Current]	T _C = 25°C	-	3.6	-	Α
	Current		T _C = 175°C	-	8.0	-	
Q _{rr}	Diode Reverse Recovery Charge]	T _C = 25°C	-	76	-	nC
			T _C = 175°C	-	800	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

OFF CHARACTERISTICS BV_{CES} Collector to Emitter Breakdown Voltage V_{GE} = 0 V, I_{C} = 250 μA 650 - - V V V V V V V V	Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ABV _{CES} / ΔT _J Temperature Coefficient of Breakdown Voltage V _{GE} = 0 V, I _C = 250 μA - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.6 - 0.	OFF CHARAC	TERISTICS	•	•	•		
Collector Cut-Off Current	BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	650	-	-	V
GES G-E Leakage Current VGE = VGES, VCE = 0 V - - ±400 nA	ΔBV_{CES} / ΔT_{J}	•	V_{GE} = 0 V, I_{C} = 250 μA	-	0.6	-	V/°C
Vos	I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μΑ
$ \begin{array}{c} V_{GE(th)} & G-E \ Threshold \ Voltage \\ V_{CE(sat)} & Collector \ to \ Emitter \ Saturation \ Voltage \\ V_{CE(sat)} & Collector \ to \ Emitter \ Saturation \ Voltage \\ \hline V_{CE(sat)} & I_{C} = 40 \ A, \ V_{GE} = 15 \ V \\ \hline I_{C} = 40 \ A, \ V_{GE} = 15 \ V, \\ \hline I_{C} = 175^{\circ}C & - 2.1 & - V \\ \hline V_{CE(sat)} & - 2.1 & - V \\ \hline \hline DYNAMIC \ CHARACTERISTICS \\ \hline C_{ies} & Input \ Capacitance & V_{CE(sat)} & V_{CE(sat)} & - 1880 & - PF \\ \hline C_{oes} & Output \ Capacitance & Image: V_{CE(sat)} & - 1800 & - PF \\ \hline C_{res} & Reverse \ Transfer \ Capacitance & Image: V_{CC(sat)} & - 1800 & - PF \\ \hline C_{res} & Reverse \ Transfer \ Capacitance & Image: V_{CC(sat)} & - 1800 & - PF \\ \hline C_{res} & Reverse \ Transfer \ Capacitance & Image: V_{CC(sat)} & - 1800 & - PF \\ \hline C_{res} & Reverse \ Transfer \ Capacitance & Image: V_{CC(sat)} & - 12 \ Info \ Ins \\ \hline V_{GC(sat)} & Turn-On \ Delay \ Time & V_{CC(sat)} & - 12 \ Info \ Ins \\ \hline V_{GC(sat)} & Turn-Off \ Delay \ Time & - 12 \ Info \ Ins \\ \hline C_{res} & Total \ Switching \ Loss & - 0.82 \ I.23 \ Ind \\ \hline C_{res} & Total \ Switching \ Loss & - 1.08 \ I.57 \ Inductive \ Load, \ T_{C} = 175^{\circ}C & - 22 \ - Ins \\ \hline C_{res} & Turn-Off \ Delay \ Time & - 16 \ Inductive \ Load, \ T_{C} = 175^{\circ}C & - 16 \ Ins \\ \hline C_{res} & Turn-Off \ Delay \ Time & - 16 \ Inductive \ Load, \ T_{C} = 175^{\circ}C & - 16 \ Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Inductive \ Load, \ T_{C} = 175^{\circ}C & - 16 \ Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - Ins \\ \hline C_{res} & Turn-Off \ Switching \ Loss & - $	I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	ON CHARACT	ERISTICS					
C ₁ = 40 A V _{GE} = 15 V, C ₁ = 175°C C ₁ C ₂ = 10 V C ₁ = 175°C C ₂ = 15 V, C ₃ = 15 V, C ₄ = 15 V, C ₅ = 175°C C ₆ = 1880 C ₇ = 1880	V _{GE(th)}	G-E Threshold Voltage	$I_C = 250 \mu A, V_{CE} = V_{GE}$	3.5	4.5	6.0	V
T _C = 175°C	V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 40 A, V _{GE} = 15 V	-	1.9	2.5	V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$			I _C = 40 A, V _{GE} = 15 V, T _C = 175°C	-	2.1	-	V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	DYNAMIC CHA	ARACTERISTICS					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	C _{ies}	Input Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$	-	1880	-	pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	C _{oes}	Output Capacitance	f = 1 MHz	-	180	-	pF
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	C _{res}	Reverse Transfer Capacitance		-	50	-	pF
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	SWITCHING C	HARACTERISTICS					-
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{d(on)}	Turn-On Delay Time		-	12	16	ns
t _f Fall Time - 13 17 ns E _{on} Turn-On Switching Loss - 0.82 1.23 mJ E _{off} Turn-Off Switching Loss - 0.26 0.34 mJ E _{ts} Total Switching Loss - 1.08 1.57 mJ t _d (on) Turn-On Delay Time VCC = 400 V, IC = 40 A, RG = 6 Ω, VGE = 15 V, Inductive Load, TC = 175°C - 15 - ns t _d (off) Turn-Off Delay Time - 116 - ns t _f Fall Time - 16 - ns E _{on} Turn-On Switching Loss - 1.08 - mJ E _{off} Turn-Off Switching Loss - 0.60 - mJ E _{ts} Total Switching Loss - 1.68 - mJ Q _g Total Gate Charge VCE = 400 V, IC = 40 A, VGE = 40 A, VGE = 15 V - 119 180 nC Q _g Gate to Emitter Charge VCE = 400 V, IC = 40 A, VGE = 15 V - 113 20 nC	t _r	Rise Time		-	20	28	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{d(off)}	Turn-Off Delay Time		-	92	120	ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _f	Fall Time		-	13	17	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	E _{on}	Turn-On Switching Loss		-	0.82	1.23	mJ
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	E _{off}	Turn-Off Switching Loss		-	0.26	0.34	mJ
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	E _{ts}	Total Switching Loss		-	1.08	1.57	mJ
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	t _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A},$	-	15	-	ns
tf Fall Time - 16 - ns Eon Turn-On Switching Loss - 1.08 - mJ Eoff Turn-Off Switching Loss - 0.60 - mJ Ets Total Switching Loss - 1.68 - mJ Qg Total Gate Charge VCE = 400 V, IC = 40 A, VGE = 40 A, VGE = 15 V - 119 180 nC Qge Gate to Emitter Charge VGE = 15 V - 13 20 nC	t _r	Rise Time	$R_G = 6 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	-	22	-	ns
Eon Turn-On Switching Loss - 1.08 - mJ Eoff Turn-Off Switching Loss - 0.60 - mJ Ets Total Switching Loss - 1.68 - mJ Qg Total Gate Charge VCE = 400 V, IC = 40 A, VGE = 400 A, VGE = 400 A, VGE = 15 V - 119 180 nC Qge Gate to Emitter Charge VGE = 15 V - 13 20 nC	t _{d(off)}	Turn-Off Delay Time		-	116	-	ns
Eoff Turn-Off Switching Loss - 0.60 - mJ Ets Total Switching Loss - 1.68 - mJ Qg Total Gate Charge V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V - 119 180 nC Qge Gate to Emitter Charge - 13 20 nC	t _f	Fall Time		-	16	-	ns
Ets Total Switching Loss - 1.68 - mJ Qg Total Gate Charge V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V - 119 180 nC Qge Gate to Emitter Charge - 13 20 nC	E _{on}	Turn-On Switching Loss		-	1.08	-	mJ
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	E _{off}	Turn-Off Switching Loss		-	0.60	-	mJ
Q _{ge} Gate to Emitter Charge $V_{GE} = 15 \text{ V}$ - 13 20 nC	E _{ts}	Total Switching Loss		-	1.68	-	mJ
Q _{ge} Gate to Emitter Charge – 13 20 nC	Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 40 A,	-	119	180	nC
Q _{gc} Gate to Collector Charge – 58 90 nC	Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	13	20	nC
	Q _{gc}	Gate to Collector Charge		-	58	90	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

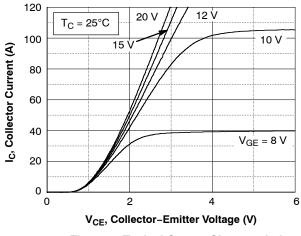


Figure 1. Typical Output Characteristics

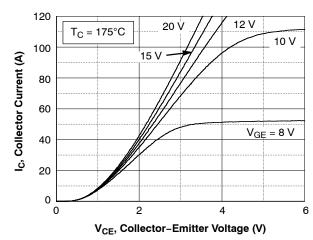


Figure 2. Typical Output Characteristics

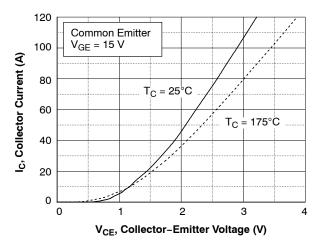


Figure 3. Typical Saturation Voltage Characteristics

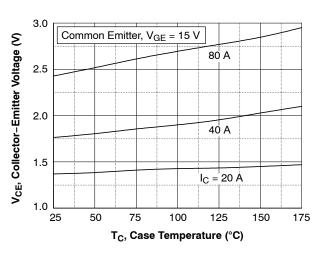


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

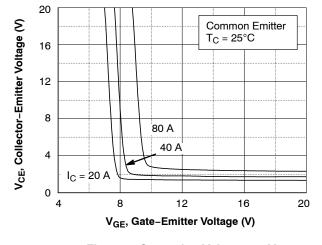


Figure 5. Saturation Voltage vs. V_{GE}

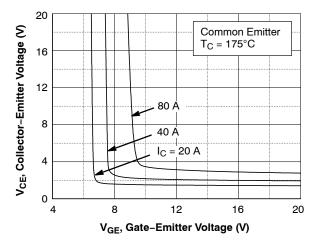


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

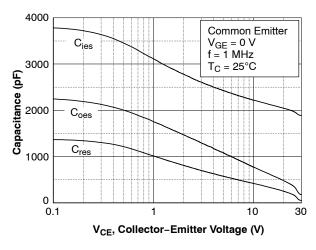


Figure 7. Capacitance Characteristics

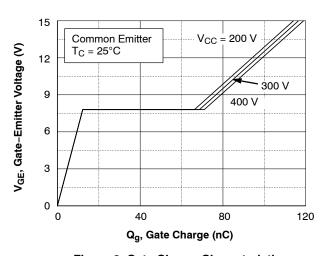


Figure 8. Gate Charge Characteristics

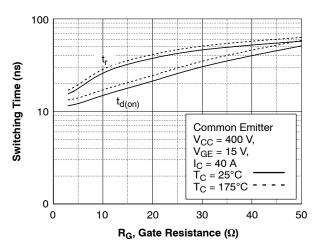


Figure 9. Turn-on Characteristics vs. Gate Resistance

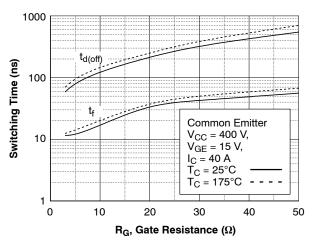


Figure 10. Turn-off Characteristics vs. Gate Resistance

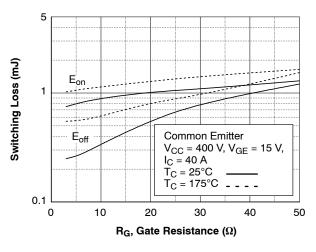


Figure 11. Switching Loss vs. Gate Resistance

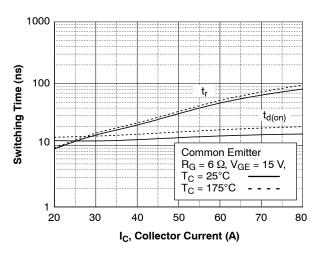


Figure 12. Turn-on Characteristics vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

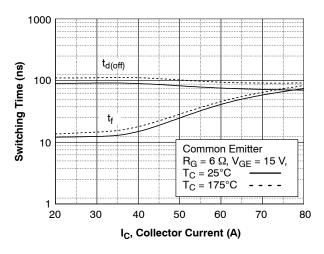


Figure 13. Turn-off Characteristics vs. Collector Current

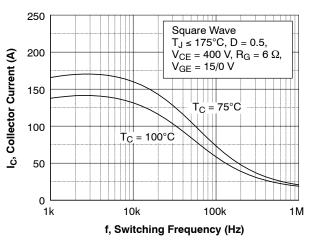


Figure 15. Load Current Vs. Frequency

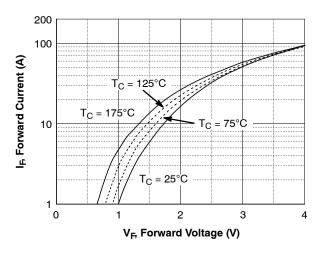


Figure 17. Forward Characteristics

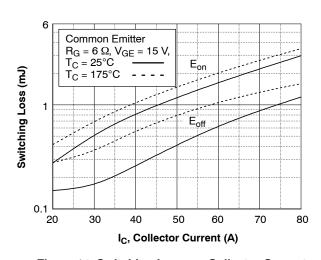


Figure 14. Switching Loss vs. Collector Current

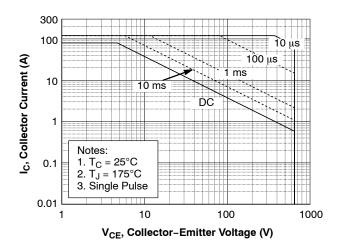


Figure 16. SOA Characteristics

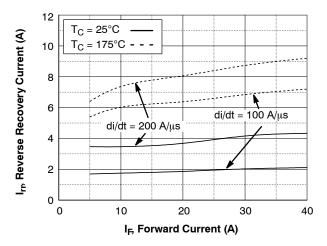


Figure 18. Reverse Recovery Current

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

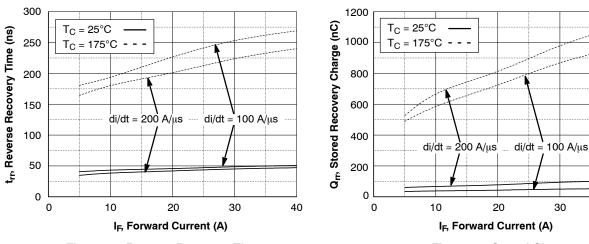


Figure 19. Reverse Recovery Time

Figure 20. Stored Charge

30

40

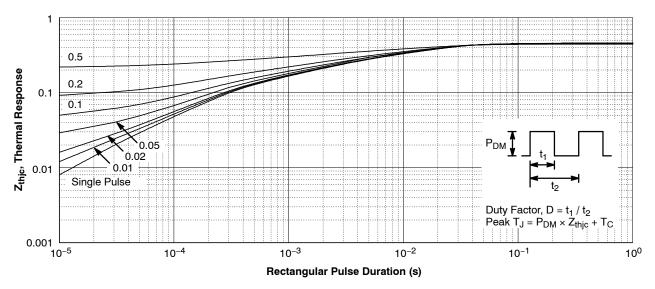


Figure 21. Transient Thermal Impedance of IGBT

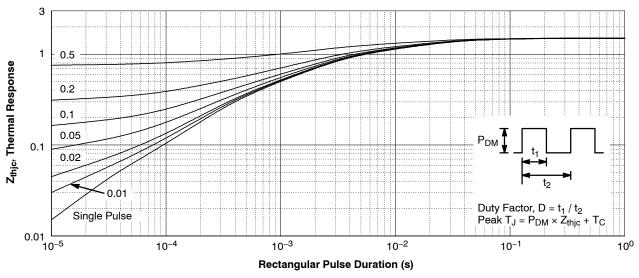
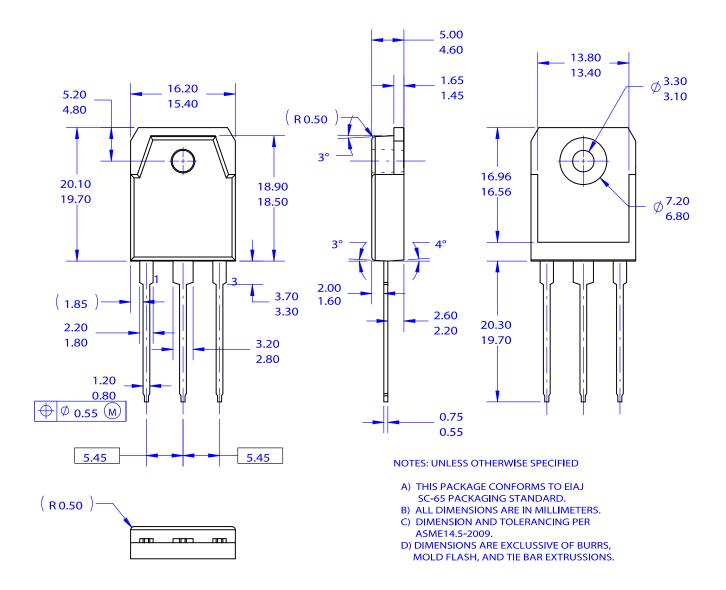


Figure 22. Transient Thermal Impedance of Diode



TO-3P-3LD / EIAJ SC-65, ISOLATED CASE 340BZ ISSUE O

DATE 31 OCT 2016



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